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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/812,602	03/30/2004	Shinichiro Nohdo	9792909-5846 3173		
26263 7590 09/13/2007 SONNENSCHEIN NATH & ROSENTHAL LLP P.O. BOX 061080			EXAMINER		
			SLOMSKI, REBECCA		
WACKER DRIVE STATION, SEARS TOWER CHICAGO, IL 60606-1080		S TOWER	ART UNIT	PAPER NUMBER	
,			2877		
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Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

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		Application No.	Ar	oplicant(s)			
	κ	10/812,602	NO	NOHDO, SHINICHIRO			
	Office Action Summary	Examiner	Ar	t Unit			
		Rebecca C. Sloms	кі 28	77			
Period	The MAILING DATE of this communication app I for Reply	pears on the cover s	heet with the corre	spondence address			
A : W - [	SHORTENED STATUTORY PERIOD FOR REPL' HICHEVER IS LONGER, FROM THE MAILING D. Extensions of time may be available under the provisions of 37 CFR 1.1 after SIX (6) MONTHS from the mailing date of this communication. If NO period for reply is specified above, the maximum statutory period realize to reply within the set or extended period for reply will, by statute Any reply received by the Office later than three months after the mailing parened patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COM 36(a). In no event, however will apply and will expire SIX e, cause the application to b	IMUNICATION.  In, may a reply be timely fix  (6) MONTHS from the necome ABANDONED (3)	iled nailing date of this communication. 5 U.S.C. § 133).			
,	<u> </u>	Responsive to communication(s) filed on <u>24 July 2007</u> .					
· .	This action is <b>FINAL</b> . 2b) ☐ This action is non-final.						
3)	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.						
	Gosea in accordance with the practice under t	parte Quayle, 19	,	r.G. 210.			
Dispo	sition of Claims						
5) 6) 7)	<ul> <li>✓ Claim(s) 1-20 is/are pending in the application 4a) Of the above claim(s) is/are withdra</li> <li>✓ Claim(s) is/are allowed.</li> <li>✓ Claim(s) 1-20 is/are rejected.</li> <li>✓ Claim(s) is/are objected to.</li> <li>✓ Claim(s) are subject to restriction and/or</li> </ul>	wn from considerat					
Appli	cation Papers						
10)	<ul> <li>☐ The specification is objected to by the Examine</li> <li>☑ The drawing(s) filed on 30 March 2004 is/are:         Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct     </li> <li>☐ The oath or declaration is objected to by the Examine</li> </ul>	a)⊠ accepted or bedrawing(s) be held interestion is required if the	abeyance. See 37 drawing(s) is object	CFR 1.85(a). ed to. See 37 CFR 1.121(d).			
Priori	ty under 35 U.S.C. § 119						
12)	<ul> <li>Acknowledgment is made of a claim for foreign a)</li></ul>	ts have been receiv ts have been receiv prity documents hav nu (PCT Rule 17.2(a	ved. ved in Application ve been received i a)).	No			
Attach	ment(s)						
1) 🛛 I	Notice of References Cited (PTO-892)		nterview Summary (PT				
3) 🔯 (	Notice of Draftsperson's Patent Drawing Review (PTO-948) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08 Paper No(s)/Mail Date <u>01/23/07</u> .	5) 🔲 N	Paper No(s)/Mail Date  5) Notice of Informal Patent Application (PTO-152)  6) Other:				

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### DETAILED ACTION

## Claim Rejections - 35 USC § 112

The following is a quotation of the first paragraph of 35 U.S.C. 112:

The specification shall contain a written description of the invention, and of the manner and process of making and using it, in such full, clear, concise, and exact terms as to enable any person skilled in the art to which it pertains, or with which it is most nearly connected, to make and use the same and shall set forth the best mode contemplated by the inventor of carrying out his invention.

1. Claims 1-20 are rejected under 35 U.S.C. 112, first paragraph, as failing to comply with the written description requirement. The claim(s) contains subject matter which was not described in the specification in such a way as to reasonably convey to one skilled in the relevant art that the inventor(s), at the time the application was filed, had possession of the claimed invention.

The amended limitation of "a third interval between adjacent dot pattern groups, the third interval being wider than an interval between the dot patterns" (lines 11-12 of claim 1, lines 11-12 of claim 6, lines 14-15 of claim 9, and lines 12-13 of claim 15) has not been previously disclosed.

# Claim Rejections - 35 USC § 102

The text of those sections of Title 35, U.S. Code not included in this action can be found in a prior Office action.

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Claims 1 – 10, 12-16, and 18-20 are rejected under 35 U.S.C. 102(b) as being anticipated by Miyatake (U. S. Patent # 6,046,508).

- 2. With respect to claims 1 and 6, Miyatake discloses position detecting marks comprising:
  - Alignment marks on an exposure surface, the alignment marks having edges for scattering inspection light for alignment during an exposure (Col.4, L 27-34)
  - The alignment mark is configured to have a plurality of dot pattern groups,
     each of the dot pattern groups being projections from the exposure surface
     and configured to have a plurality of dot patterns arrayed in a predetermined
     direction (Col.4, L 22-23, Figure 2C, 13A)
  - The plurality of dot pattern groups are arrayed in the predetermined direction
    with an interval between the dot patterns groups, the interval being wider
    than an interval between the dot patterns (Figure 2C, 13A, y1)
  - The plurality of dot pattern groups are arrayed in a second predetermined direction perpendicular to the first predetermined direction with a third interval between adjacent dot pattern groups, the third interval being wider than an interval between the dot patterns (Figure 2C, 14A, x1)
- 3. With respect to claim 9, Miyatake discloses a position detecting method comprising:
  - Radiating inspection light for alignment to a surface of wafer in such a way that the inspection light is incident on an alignment mark in a surface of the

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wafer and scattered therein before exposure with an exposure mask (Col.2, L 8-21)

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- Wherein the exposure mask has alignment marks, the alignment marks being configured to have a plurality of dot pattern groups, each of the dot pattern groups being configured to have a plurality of dot patterns arrayed in a predeterminied direction, and the plurality of dot pattern groups being arrayed in the predetermined direction with an interval between the dot pattern groups, the interval being wider than an interval between the dot patterns (Col.4, L 22-23, Figure 2C)
- The alignment mark of the wafer has a same pattern as that of the dot pattern of the exposure mask (Figure 2A, Col.5, L 51-53)
- The plurality of dot pattern groups are arrayed in a second predetermined direction perpendicular to the first predetermined direction with a third interval between adjacent dot pattern groups, the third interval being wider than an interval between the dot patterns (Figure 2C, 14A, x1)
- 4. With respect to claim 15, Miyatake discloses a position detecting method comprising:
  - Performing an alignment by causing scattering of inspection light for alignment at an alignment mark on a surface of an exposure mask (Abstract)
  - Performing an exposure of a wafer via the exposure mask (Abstract)

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- Wherein the exposure mask is configured to have alignment marks, the alignment marks being configured to have a plurality of dot pattern groups, each of the dot pattern groups being configured to have a plurality of dot patterns arrayed in a predeterminied direction, and the plurality of dot pattern groups being arrayed in the predetermined direction with an interval between the dot pattern groups, the interval being wider than an interval between the dot patterns (Col.4, L 22-23, Figure 2C)
- The plurality of dot pattern groups are arrayed in a second predetermined direction perpendicular to the first predetermined direction with a third interval between adjacent dot pattern groups, the third interval being wider than an interval between the dot patterns (Figure 2C, 14A, x1)
- 5. With respect to claims 2, 12 and 18, Miyatake discloses all of the limitations as applied to claims 1, 9 and 15 above. In addition, Miyatake discloses:
  - Dot pattern is formed by performing a proximity exposure (Col.1, L 15-16)
- 6. With respect to claim 3, Miyatake discloses all of the limitations as applied to claim 1 above. In addition, Miyatake discloses:
  - Dot pattern is a raised rectangular pattern (Col.5, L 45-47)
- 7. With respect to claims 4 and 7, Miyatake discloses all of the limitations as applied to claims 1 and 6 above. In addition, Miyatake discloses:

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8. With respect to claims 5 and 8, Miyatake discloses all of the limitations as applied to claims 1 and 6 above. In addition, Miyatake discloses:

- Alignment marks are disposed at a plurality of portions in respective directions
   (Figure 2C)
- 9. With respect to claims 10 and 16, Miyatake discloses all of the limitations as applied to claims 9 and 15 above. In addition, Miyatake discloses:
  - The inspection light for alignment is incident on the exposure mask and the wafer in an oblique direction (Col.4, L 27, Figure 1)
- 10. With respect to claims 13 and 19, Miyatake discloses all of the limitations as applied to claims 9 and 15 above. In addition, Miyatake discloses:
  - The detecting of scattered inspection light is performed by differentiation processing of a signal strength along the arrangement direction of dot patterns (Col.9, L 24-37)
- 11. With respect to claim 14 and 20, Miyatake discloses all of the limitations as applied to claims 9 and 15 above. In addition, Miyatake discloses:
  - Peaks of higher signal strength with stronger scattering of the inspection light
     are arranged periodically in the direction of arrayed dot pattern (Col.12, L 50-61)

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## Claim Rejections - 35 USC § 103

The text of those sections of Title 35, U.S. Code not included in this action can be found in a prior Office action.

Claims 11 and 17 are rejected under 35 U.S.C. 103(a) as being unpatentable over Miyatake U.S. Patent # 6,046,508 in view of Schulz U.S. Publication 2003/0044702.

12. With respect to claims 11 and 17, Miyatake discloses all of the limitations as applied to claims 9, 10, 15 and 16 above. However, Miyatake fails to disclose the inspection light is radiated onto the exposure surface in such a way that the plane of incidence of the inspection light is parallel to the arrangement direction of the dot pattern.

Schulz discloses semiconductor measuring device comprising:

Inspection light is radiated onto the exposure surface in such a way that the plane
of incidence of the inspection light is parallel to the arrangement direction of the
dot pattern (P.0030)

It would have been obvious to one of ordinary skill in the art at the time the invention was conceived to use the parallel incident light of Schulz in the position detecting method of Miyatake since it would increase sensitivity along that direction. (Schulz, P.0030)

# Response to Arguments

The following is in response to the arguments presented by the applicant in the response to the April 24, 2007 Office Action.

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13. Applicant's arguments, see Page 9, with respect to the rejection(s) of claim(s) 1, and 3-8 under 35 U.S.C. 102 anticipated by Tominaga, have been fully considered and in view of the amendment are persuasive. The rejection has been withdrawn.

14. Applicant's arguments, see Page 7, with respect to the rejection of claims 1-10, 12-16, and 18-20 under Miyatake have been fully considered but are not persuasive. The rejection, with the addition of the amendment, has been maintained.

#### Citation

The prior art made of record and not relied upon is considered pertinent to applicant's disclosure: Adel et al. U.S. Patent # 6,921,916 discloses overlay marks in a plurality of groups.

### Conclusion

Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, THIS ACTION IS MADE FINAL. See MPEP § 706.07(a).

Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to

37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Rebecca C. Slomski whose telephone number is 571-272-9787. The examiner can normally be reached on Monday through Thursday, 7:30 am - 5:00 pm EST.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Gregory J. Toatley, Jr. can be reached on 571-272-2059. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

Rebecca C. Slomski Assistant Patent Examiner

rcs